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Efficient Safety Circuit for Electronic Ballast

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INTRODUCTION

The self-oscillating circuit, commonly used in the low cost half-bridge converter, is prone to thermal runaway when the fluorescent lamp does not strike. As a consequence, either the switches are oversized to sustain such a fault condition, or the circuit includes a safety network to avoid this risk. Although several schematics are usable to perform such a function, the one described in this paper is easy to implement and does not influence the normal operation of the converter.

PROBLEM DESCRIPTION

The schematic diagram of the evaluation board given in Figure 1 is built around a standard half-bridge self-oscillating converter to feed the lamp, together with a Power Factor Correction circuit in the front end.

This topology makes profit of the RLC series resonant network. It can indefinitely sustain the open load condition (i.e., broken filament) since there are neither a current flow nor voltage spikes in the circuit under this mode.

When the lamp runs in steady state, the current is limited essentially by the impedance of the series inductor L1 and, thanks to the free wheeling diodes connected collector to emitter, there are no voltage spikes across the power transistors.

The operation of the ballast is more complex during the start-up sequence, when the circuit operates close to the resonance built with L1/C11/C12/R18, yielding large peak collector current and high voltage at the L1/C11 node, hence across the lamp. Usually, the lamp strikes rapidly, depending upon the temperature and the peak voltage applied across the electrodes. A typical four-foot long tube needs 800 V to strike, with a preheating time of around 500 ms for the filaments. However, at the end of life, or under worst case conditions (low line voltage, negative ambient temperature, etc.), the lamp may not strike and the circuit will continuously operate in the start-up mode, yielding maximum losses in the power transistors. Such level of losses generate heat which, unless the devices are heavily heatsunk, will increase the die temperature above the maximum rating in a few seconds. At this moment, the transistors are exposed to a high thermal runaway risk and TO220 packaged parts may blow up in less than two minutes. This time is shorter for smaller packages like the DPAK or the TO92.

APPLICATION NOTE

SAFETY NETWORK DESCRIPTION

The schematic given in Figure 4, partially reproduced in Figure 2, includes a safety circuit built with R8, D10, Q4, the sense network C16, D5, C10, R17, R16, and D11 being shown in Figure 4.

Basically, the strike voltage is scaled down by the resistor divider R16/R17 and rectified by diode D11. The capacitors C10 and C16 give a time constant to delay the action, allowing the start up of a normal lamp for about 5 seconds. Capacitor C18 filters the gate voltage, making sure that noise will not trigger the thyristor. When the voltage across C10 exceeds the zener value of D5, the thyristor Q4 is triggered, pulling the low side of the winding T1d to ground. The Vaux voltage, supplied by the PFC, is applied across D10/R8/N4 and the DC current I_s forces the toroid into the saturation region by the extra flux coming from $I_s \cdot T1d$.

Consequently, the output to base positive coupling of each transistor becomes negligible, the μr being now equal to 1, and the converter stops immediately. Since the value of I_s is made larger than the holding current I_H , the SCR stays ON until the line is switched OFF: the fault is memorized and the module is fully protected.

On the other hand, I_s shunts to ground all of the energy coming from the pre-charge resistor R3 (see Figure 4) and the Vaux winding connected across the PFC output inductor: the front end stage is switched off, since the Vaux drops below the low voltage threshold of IC; and the power dissipated by Joule's effect in R8 is negligible.

Since a 10 mm toroid is large enough to accommodate 20 turns for T1d (AWG 32 or lower), one needs only 50 mA of DC current to saturate the toroid. These numbers must be recalculated for different toroid size and ferrite material.

Eventually, the start-up network can be deactivated when the safety circuit is triggered, by using two extra diodes to clamp the voltage below the trig point of the DIAC as depicted Figure 3.

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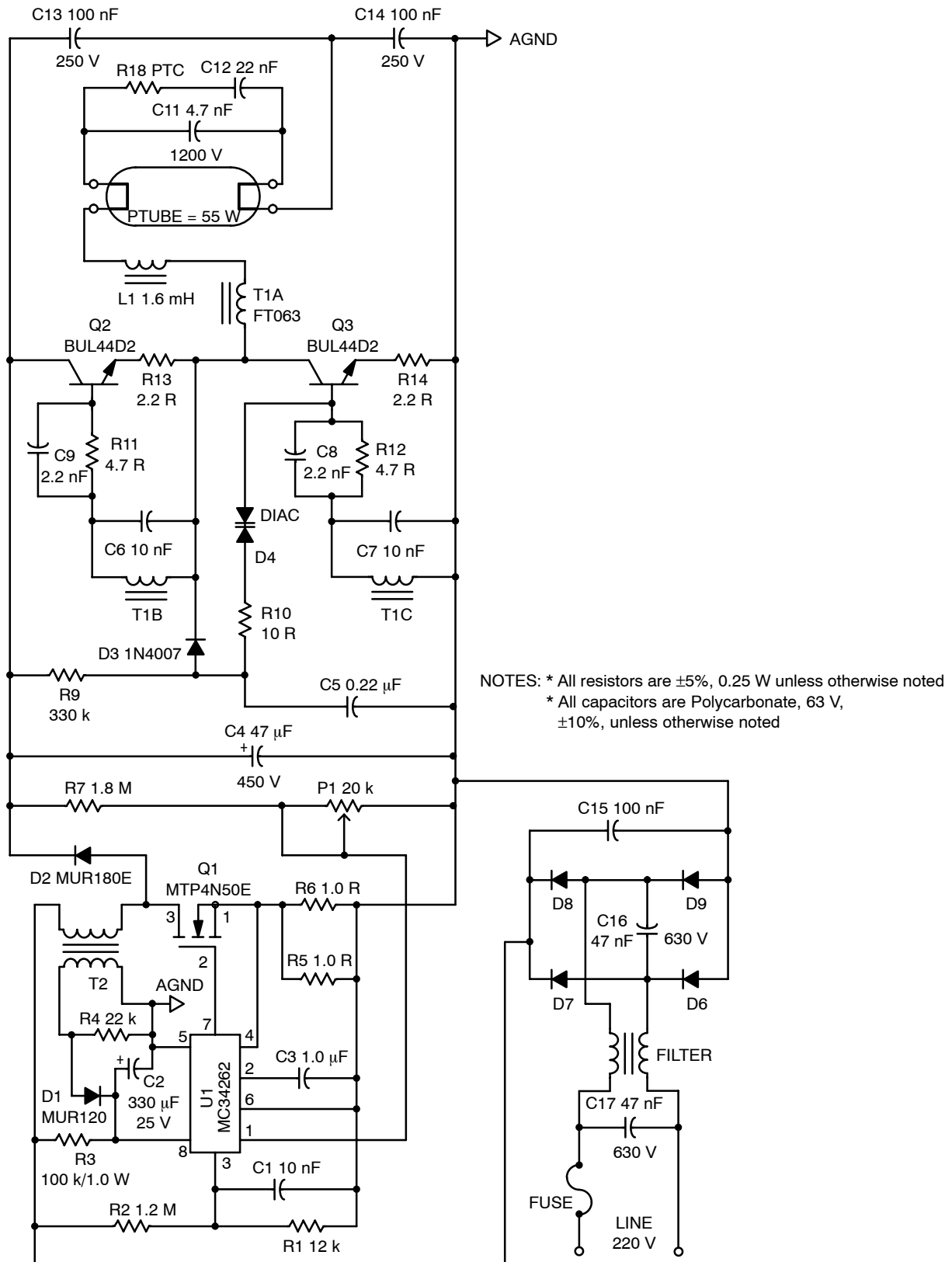
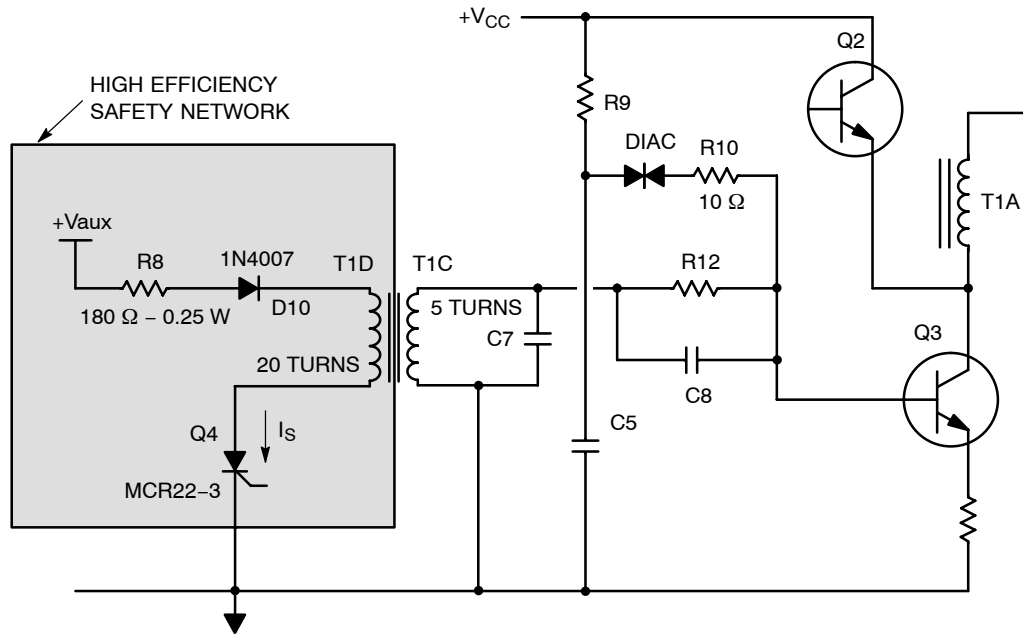


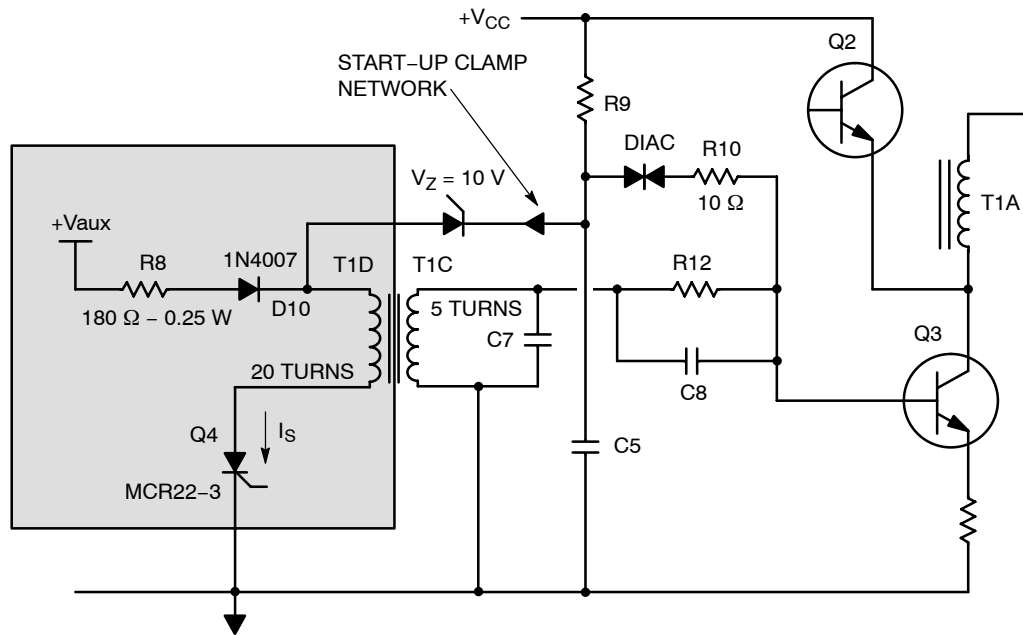
Figure 1. Standard Half Bridge Electronic Ballast Schematic Diagram

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NOTE: Partial circuit, see details and references Figure 4

Figure 2. Low Losses Safety Circuit (Patent Pending)



NOTE: Partial circuit, see details and references Figure 4

Figure 3. Deactivation of the Start-up Network (Patent Pending)

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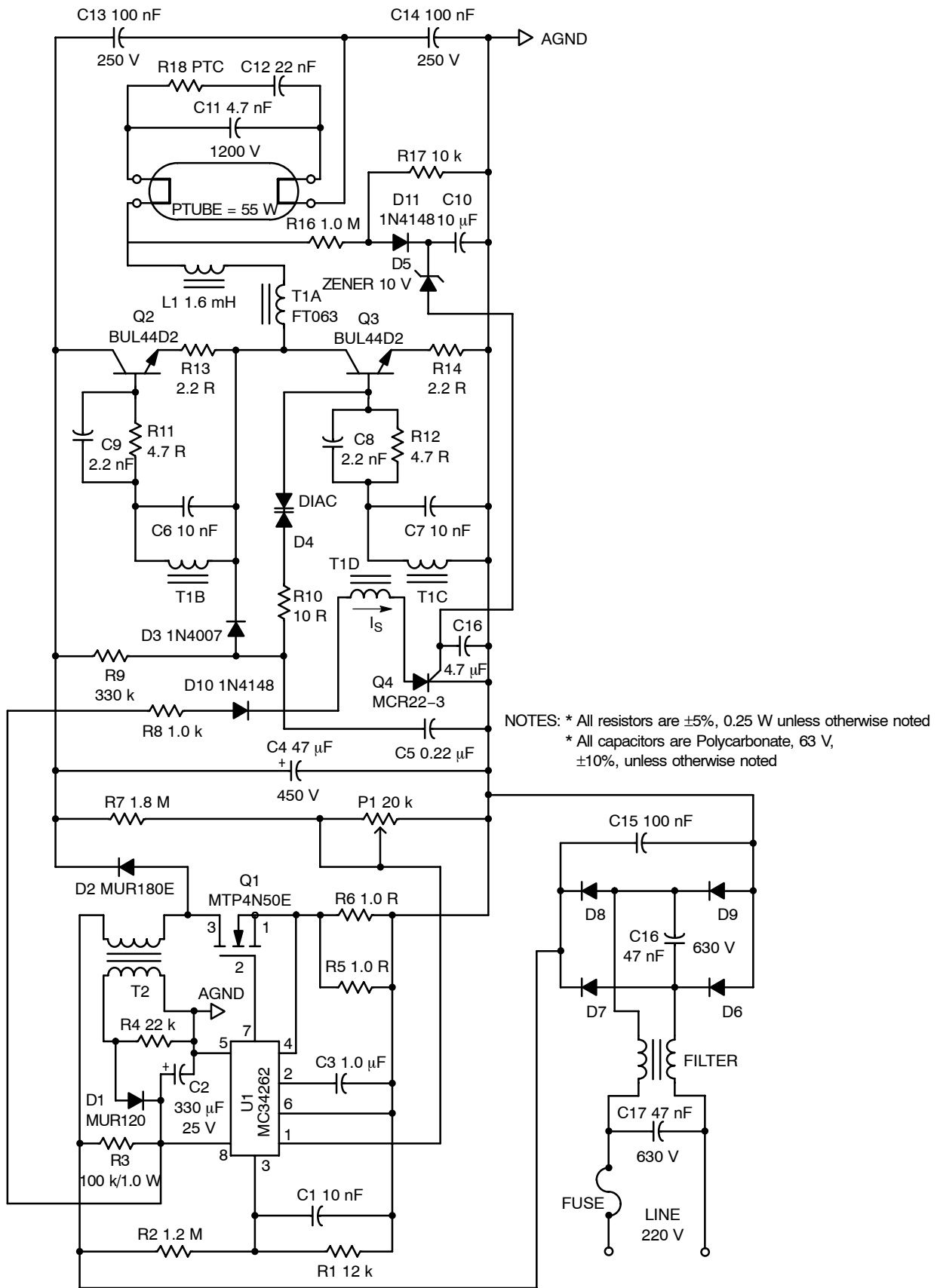


Figure 4. Typical Safety Circuit Application

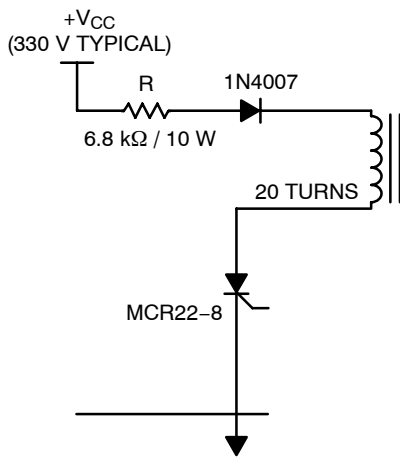


Figure 5. High Voltage Driven Safety Circuit

If the low voltage V_{aux} , or similar, is not available (i.e., module without a PFC), the current I_s can be derived from the V_{CC} line. Obviously, the components must be sized to

sustain the high voltage as depicted in Figure 5. In this case, the power dissipated into R becomes high and will generate enough heat to significantly increase the temperature inside the housing of the electronic circuit.

To overcome such a problem, the design can be improved as depicted in Figure 6. The DC current is kept at the I_H value by means of R_H , limiting the losses to less than one watt. The saturation current I_s is generated by capacitor C_s which, associated to the current limiting resistor R_T , will provide a pulse long enough to switch off the converter when the SCR is switched ON. However, once the capacitor is charged, the DC current, flowing in R_H associated with R9, becomes too low to maintain the saturation of the core. The clamp diode D_C , which is mandatory to avoid the restart of the converter, provides a path for the I'_H current. Consequently, the current flowing in the start-up resistor R9 is added to the one coming from R_H , limiting the wattage of that resistor by sharing the holding current.

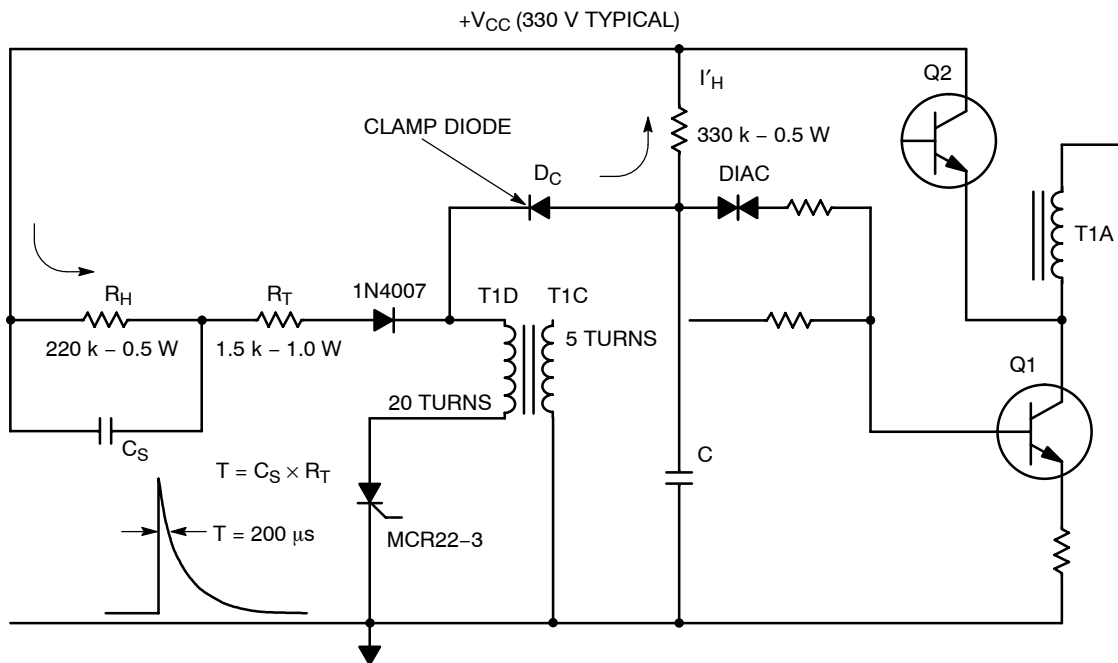


Figure 6. Improved High Voltage Driven Safety Circuit (Patent Pending)

CONCLUSION

The high end electronic ballasts can be designed with specific drivers which include all the requested circuits to perform the safety functions, the extra cost being masked by the overall complexity. The situation is very different with modules targeted for the low cost market where each extra penny is valuable. The safety circuits proposed in this paper are easy to implement and do not need sophisticated and costly components to protect the electronic ballasts against the most common lamp failure mode.

With the galvanic isolation from the base drive of the power transistor provided by the magnetic circuit, the safety

network is free from uncontrolled feedback from one circuit to the other. On the other hand, since it dumps the permeability of the magnetic core to unity, instead of shunting one base current only, both transistors are shut off simultaneously, avoiding the risk of cross conduction during the transient phase.


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Michael Bairanzade:
Electronic Lamp Ballast Design
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Notes

Notes

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